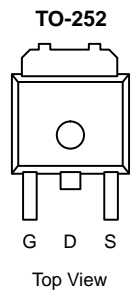




N-Channel 60-V (D-S), 175 °C MOSFET, Logic Level

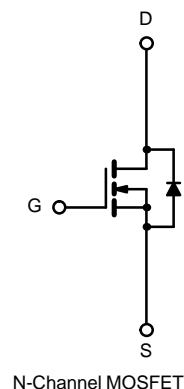
| PRODUCT SUMMARY | | |
|---------------------|---------------------------------|---------------------------------|
| V _{DS} (V) | r _{DS(on)} (Ω) | I _D (A) ^a |
| 60 | 0.022 @ V _{GS} = 10 V | 30 |
| | 0.025 @ V _{GS} = 4.5 V | 30 |

175 °C Rated
Maximum Junction Temperature
TrenchFET[®]
Power MOSFETs



Drain Connected to Tab

Order Number:
SUD40N06-25L



| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C UNLESS OTHERWISE NOTED) | | | | |
|--|-------------------------|-----------------------------------|-------------------------------------|------|
| Parameter | | Symbol | Limit | Unit |
| Gate-Source Voltage | | V _{GS} | ± 20 | V |
| Continuous Drain Current (T _J = 175 °C) ^b | T _C = 25 °C | I _D | 30 | A |
| | T _C = 100 °C | | 30 | |
| Pulsed Drain Current | | I _{DM} | 100 | |
| Continuous Source Current (Diode Conduction) | | I _S | 34 | |
| Avalanche Current | | I _{AR} | 34 | |
| Repetitive Avalanche Energy (Duty Cycle ≤ 1%) | L = 0.1 mH | E _{AR} | 58 | mJ |
| Maximum Power Dissipation | T _C = 25 °C | P _D | 75 | W |
| | T _A = 25 °C | | 1.4 ^b , 2.5 ^c | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to 175 | °C |

| THERMAL RESISTANCE RATINGS | | | | |
|-----------------------------|---------------------------|-------------------|-------|------|
| Parameter | | Symbol | Limit | Unit |
| Maximum Junction-to-Ambient | Free Air, FR4 Board Mount | R _{thJA} | 60 | °C/W |
| | Free Air, Vertical Mount | | 110 | |
| Maximum Junction-to-Case | | R _{thJC} | 2.0 | |

Notes:

- a. Package limited.
- b. Free air, vertical mount.
- c. Surface mounted on 1" x 1" FR4 Board, t ≤ 10 sec.

For SPICE model information via the Worldwide Web: <http://www.vishay.com/www/product/spice.htm>



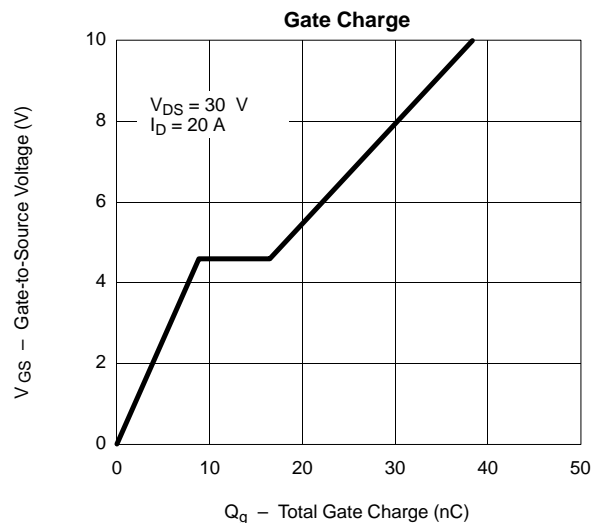
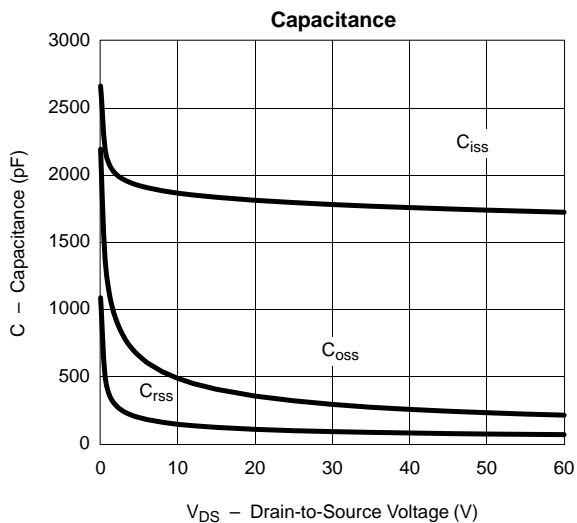
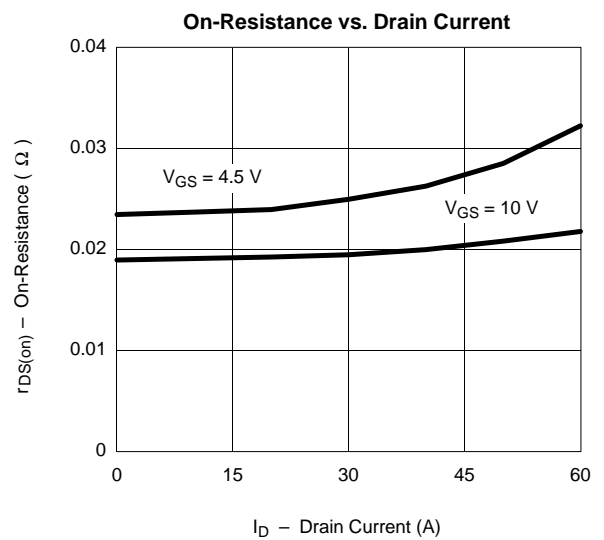
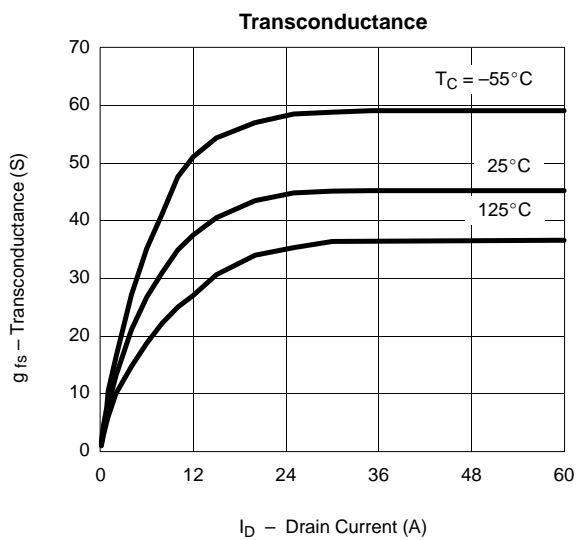
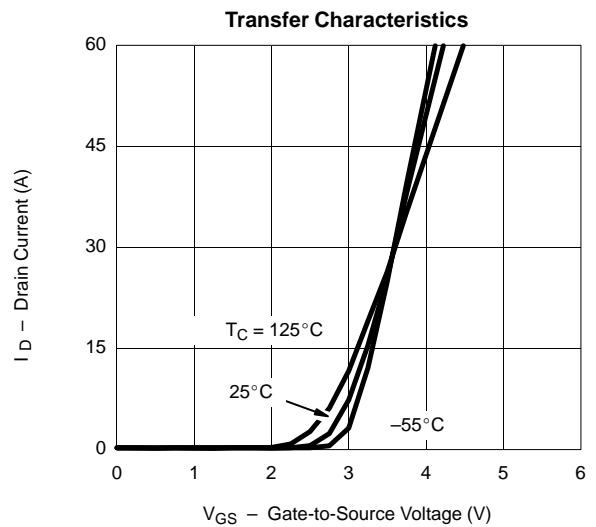
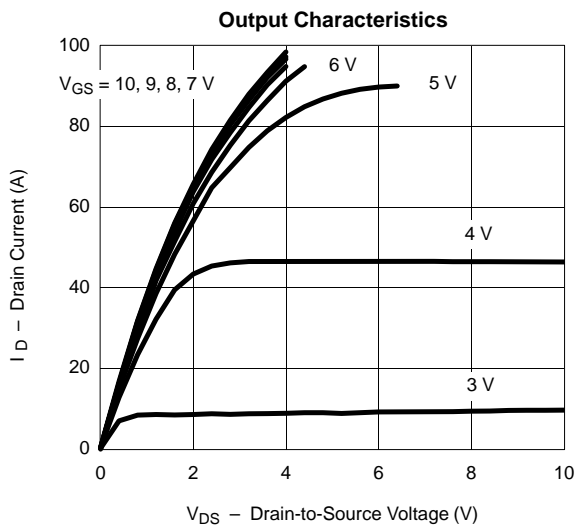
| SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED) | | | | | | |
|---|---------------|--|-----|------------------|-----------|---------------|
| Parameter | Symbol | Test Condition | Min | Typ ^a | Max | Unit |
| Static | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$ | 60 | | | V |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$ | 1.0 | 2.0 | 3.0 | |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$ | | | 1 | μA |
| | | $V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}, T_J = 125^\circ\text{C}$ | | | 50 | |
| | | $V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}, T_J = 175^\circ\text{C}$ | | | 150 | |
| On-State Drain Current ^b | $I_{D(on)}$ | $V_{DS} = 5\text{ V}, V_{GS} = 10\text{ V}$ | 20 | | | A |
| Drain-Source On-State Resistance ^b | $r_{DS(on)}$ | $V_{GS} = 10\text{ V}, I_D = 20\text{ A}$ | | | 0.022 | Ω |
| | | $V_{GS} = 10\text{ V}, I_D = 20\text{ A}, T_J = 125^\circ\text{C}$ | | | 0.043 | |
| | | $V_{GS} = 10\text{ V}, I_D = 20\text{ A}, T_J = 175^\circ\text{C}$ | | | 0.053 | |
| | | $V_{GS} = 4.5\text{ V}, I_D = 20\text{ A}$ | | | 0.025 | |
| Forward Transconductance ^b | g_{fs} | $V_{DS} = 15\text{ V}, I_D = 20\text{ A}$ | | | | S |
| Dynamic | | | | | | |
| Input Capacitance | C_{iss} | $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$ | | 1800 | | pF |
| Output Capacitance | C_{oss} | | | 350 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 100 | | |
| Total Gate Charge ^c | Q_g | $V_{DS} = 30\text{ V}, V_{GS} = 10\text{ V}, I_D = 40\text{ A}$ | | 40 | 60 | nC |
| Gate-Source Charge ^c | Q_{gs} | | | 9 | | |
| Gate-Drain Charge ^c | Q_{gd} | | | 10 | | |
| Turn-On Delay Time ^c | $t_{d(on)}$ | $V_{DD} = 30\text{ V}, R_L = 0.9\ \Omega$ $I_D \cong 20\text{ A}, V_{GEN} = 10\text{ V}, R_G = 2.5\ \Omega$ | | 10 | 20 | ns |
| Rise Time ^c | t_r | | | 9 | 20 | |
| Turn-Off Delay Time ^c | $t_{d(off)}$ | | | 28 | 50 | |
| Fall Time ^c | t_f | | | 7 | 15 | |
| Source-Drain Diode Ratings and Characteristics ($T_C = 25^\circ\text{C}$) | | | | | | |
| Pulsed Current | I_{SM} | | | | 20 | A |
| Diode Forward Voltage | V_{SD} | $I_F = 20\text{ A}, V_{GS} = 0\text{ V}$ | | 1.0 | 1.5 | V |
| Reverse Recovery Time | t_{rr} | $I_F = 20\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$ | | 48 | 100 | ns |

Notes:

- For design aid only; not subject to production testing.
- Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
- Independent of operating temperature.

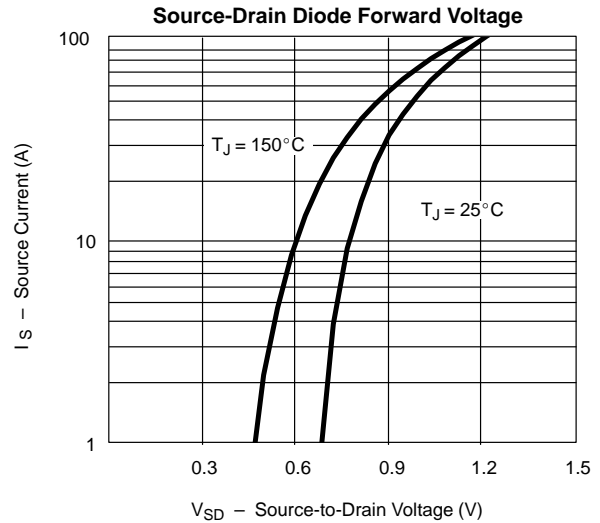
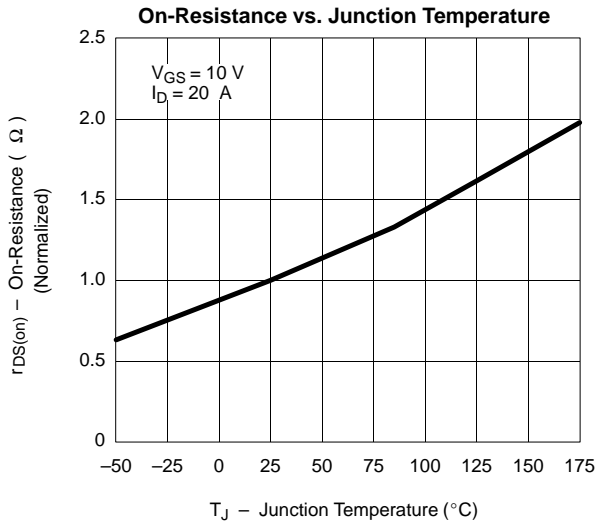


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



THERMAL RATINGS

